

Bicolor Surface Mount Chip LEDs

Technical Data

Features

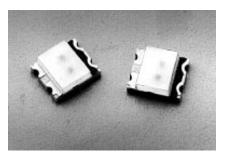
- Small Size
- Diffuse Optics
- Compatible with IR Solder Processes
- Three Combinations Available: Red/Green, Orange/Green, Yellow/Green
- Available in 8 mm Tape on 7" (178 mm) Diameter Reels

Applications

- Symbol Backlighting
- Status Indication
- Front Panel Indicator

Description

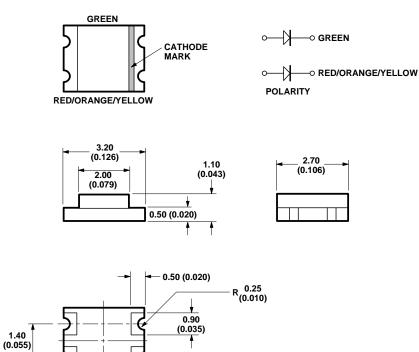
The HSMF-C65x series of bicolor chip-type LEDs are designed in an industry standard package for ease of handling and use. These bicolor LEDs are available as high efficiency red/green, yellow/ green, and orange/green. HSMF-C655 HSMF-C656 HSMF-C657



The small size, low 1.1 mm profile and wide viewing angle make these LEDs excellent for backlighting applications and front panel illumination. They are compatible with IR reflow soldering processes.

Part Number	Color	Parts/Reel	
HSMF-C655	High Efficiency Red/ Green	3000	
HSMF-C656	Yellow/ Green	3000	
HSMF-C657	Orange/ Green	3000	

Package Dimensions



Notes:

1. Dimensions in mm.

2. Tolerance $\pm~0.1$ mm unless otherwise noted.

Absolute Maximum Ratings at $T_{\rm A}$ = 25 $^\circ\!{\rm C}$

Parameter	HSMF-C65x	Units	
DC Forward Current ^{[1], [2]}	25	mA	
Power Dissipation	65	mW	
Reverse Voltage ($I_R = 100 \mu A$)	5	V	
LED Junction Temperature	95	°C	
Operating Temperature Range	-25 to +80	°C	
Storage Temperature Range	-30 to +85	°C	

Notes:

1. Derate Linearly as shown in Figure 4.

2. Maximum current is for entire package.

Color	Inten (mc	inous sity I _V d) @ 20 mA Typ.	Peak Wavelength λ _{peak} (nm) Typ.	Color Dominant Wavelength λ _d ^[1] (nm) Typ.	Viewing Angle $2\theta_{1/2}$ (degrees) ^[2] Typ.	Luminous Efficacy η _V (lm/W)[3]
High Efficiency Red	1.6	5.0	639	626	155	145
Orange	1.6	4.0	606	604	155	380
Yellow	1.6	5.0	584	586	155	500
Green	4.0	9.0	566	571	155	595

Optical Characteristics at T_{A} = 25 $^{\circ}\!C$

Notes:

1. The dominant wavelength, λ_d , is derived from the 1931 CIE chromaticity diagram and represents the perceived color of the device with respect to standard illuminant D65.

2. $\theta_{1/2}$ is the off-axis angle where the luminous intensity if 1/2 the peak intensity.

3. The luminous efficacy, $\eta_V,$ is the ratio of luminous flux to radiant flux, $\phi_V\!/\!\phi_e.$

Electrical Characteristics at $T_{\rm A}$ = 25 $^\circ\!{\rm C}$

	Forward Voltage V _F (Volts) @ I _F = 20 mA		Reverse Breakdown V _R (Volts) @ I _R = 100 μA	Capacitance C (pF) V _F = 0, f = 1 MHz	Thermal Resistance RθJ-Pin
Color	Тур.	Max.	Min.	Тур.	(°C/W)
High Efficiency Red	1.9	2.6	5	4	325
Orange	2.1	2.6	5	4	325
Yellow	2.1	2.6	5	3	325
Green	2.2	3.0	5	8	325

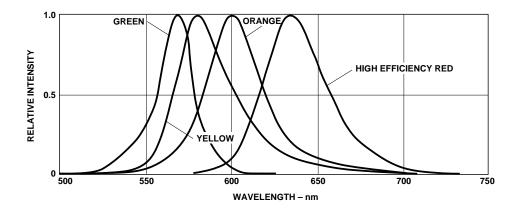


Figure 1. Relative Intensity vs. Wavelength.

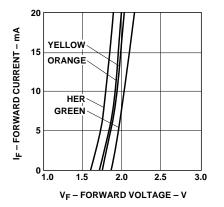


Figure 2. Forward Current vs. Forward Voltage.

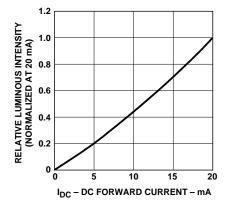


Figure 3. Relative Luminous Intensity vs. DC Forward Current.

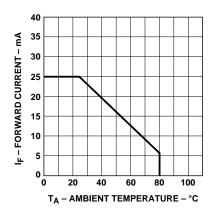
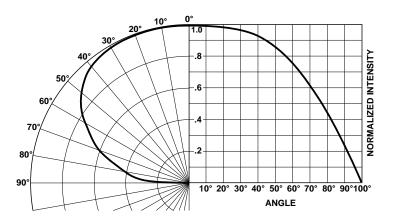


Figure 4. Maximum DC Current vs. Ambient Temperature.

4



PRE-HEAT 140-160°C PRE-HEAT 140-160°C 4°C/SEC. MAX. 4°C/SEC. MAX. TIME ---

10 SEC. MAX.-

Figure 6. Recommended Reflow Soldering Profile.

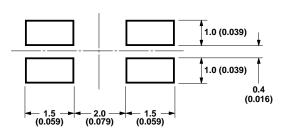
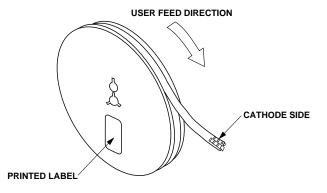
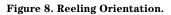


Figure 7. Recommended Solder Pattern.

Figure 5. Intensity vs. Angle.





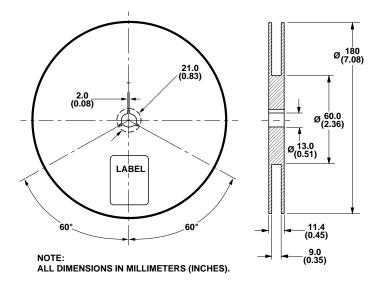


Figure 9. Reel Dimensions.

5

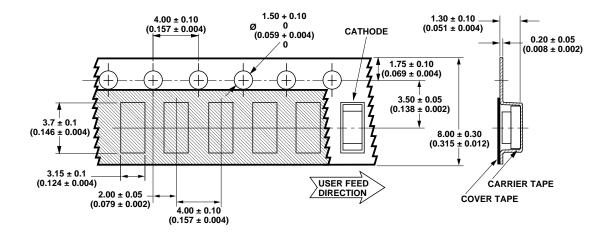


Figure 10. Tape Dimensions.

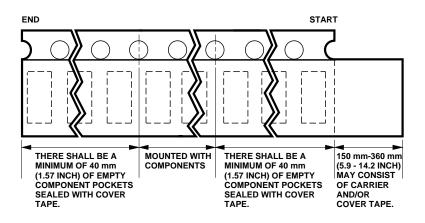


Figure 11. Tape Leader and Trailer Dimensions.

Storage Condition: 5 to 30 $^{\circ}$ C @ 60% RH max.

Baking is required under the condition:

a) the blue silica gel indicator becoming white/transparent color

b) the pack has been opened for more than 1 week

Baking recommended condition: $60 \pm 5^{\circ}$ C for 20 hours.

6



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